Features

- 0.4” (10.16mm) Digit Height
- Triple Digit Display
- Black/Grey Face, White Segment
- IC compatible, Easy assembly
- Dynamic drive connects
- RoHS Compliant, Pb Free

Description

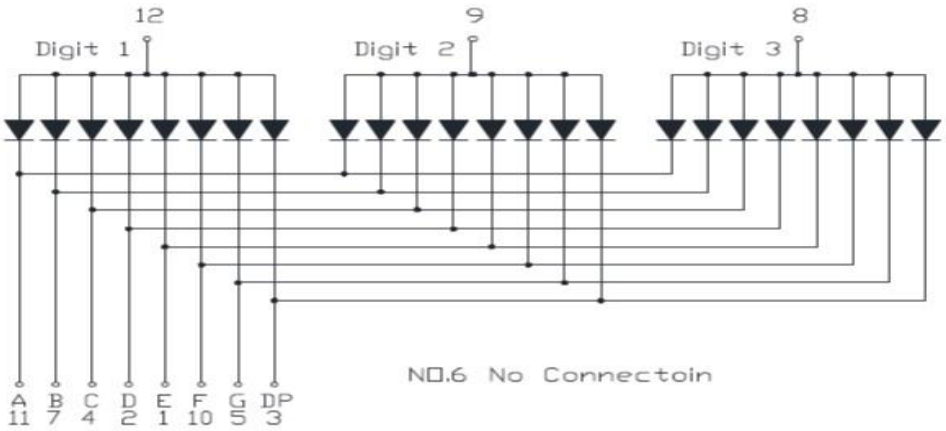
The INND-TT40 series is a 0.4” triple digit display. It is a through hole type LED display which can be used in various applications.

Applications

- Consumer Electronics
- Industrial Equipment

Internal Circuit Diagram

Common Anode



Common Cathode

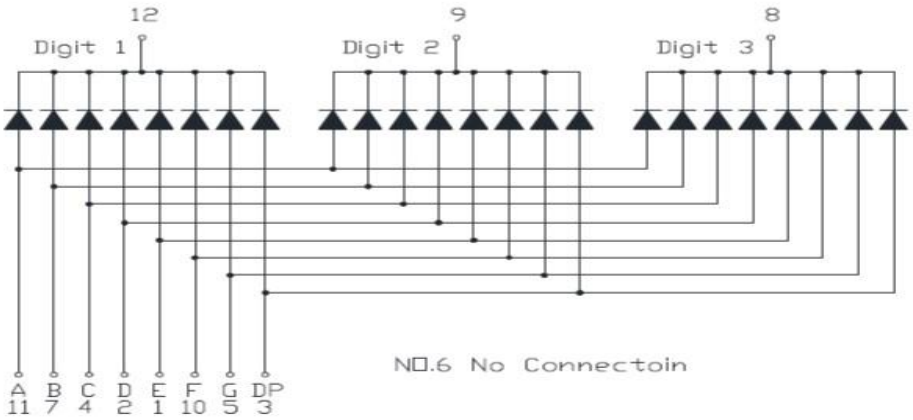


Figure 1. INND-TT40 series Internal Circuit Diagram

Package Dimensions

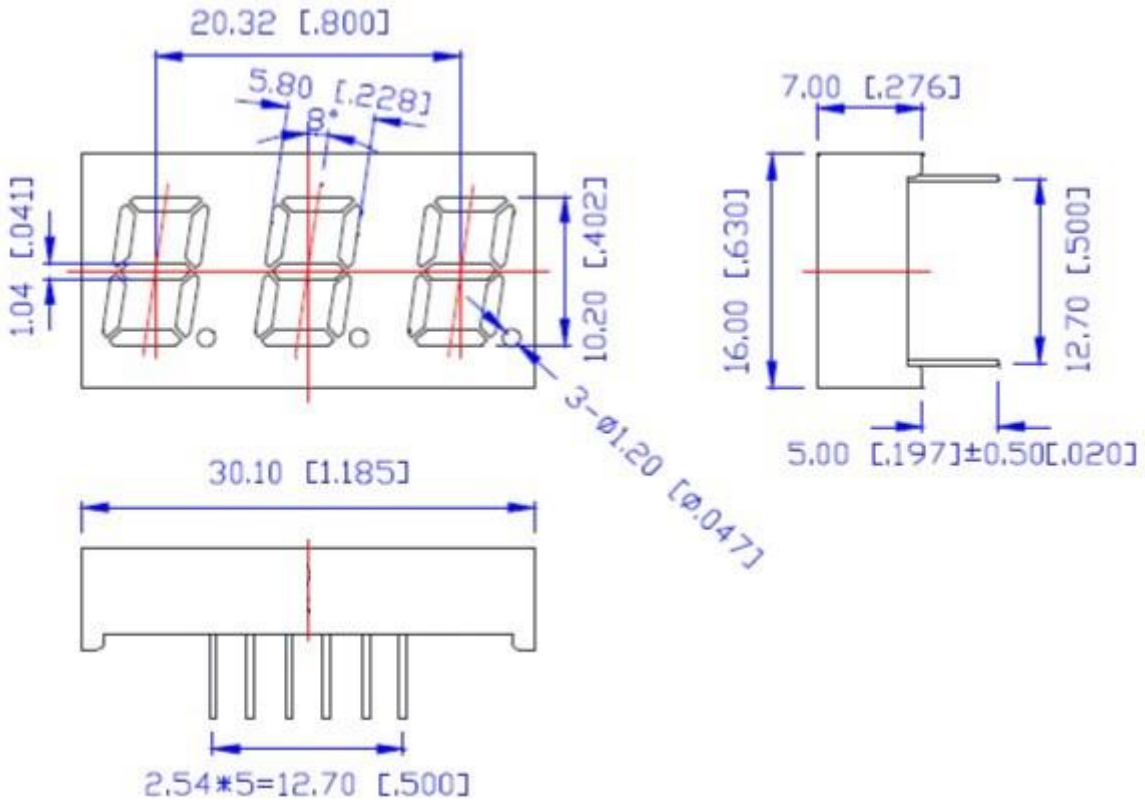


Figure 2. INND-TT40 series Package Dimensions

Notes

1. All pins are Φ0.51[.020]±0.1mm
2. Dimension in millimeter [inch], tolerance is ±0.25 [.010]. Unless otherwise noted.
3. Bending≤Length*1%.

All Light On Segments Feature & Pin Position

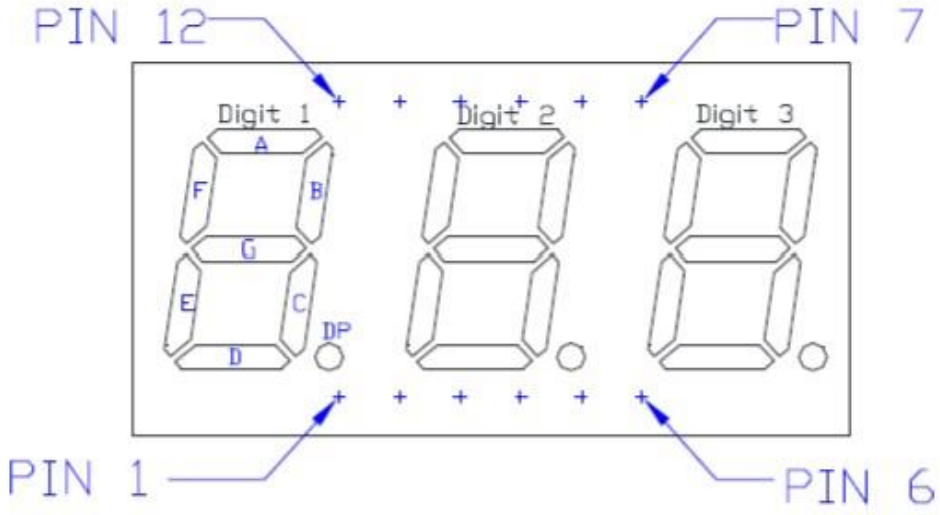


Figure 3. All Light On Segments Feature & Pin Position

Absolute Maximum Rating at 25°C (Note 1)

Product (Per Segment)	Emission Color	Technology	P_d (mW)	I_F (mA)	I_{FP}* (mA)	V_R (V)	Derate From 25°C (mA/°C)	T_{OP} (°C)	T_{ST} (°C)
INND-TT40YGXX	Yellow Green	AlGaInP	70	25	90	5	0.33	-35°C~+85°C	-35°C~+85°C
INND-TT40YXX	Yellow	AlGaInP	70	25	90	5	0.33	-35°C~+85°C	-35°C~+85°C
INND-TT40AXX	Amber	AlGaInP	70	25	90	5	0.33	-35°C~+85°C	-35°C~+85°C
INND-TT40RXX	Red	AlGaInP	70	25	90	5	0.33	-35°C~+85°C	-35°C~+85°C
INND-TT40DRXX	Deep Red	AlGaInP	70	25	90	5	0.33	-35°C~+85°C	-35°C~+85°C
INND-TT40GXX	Green	InGaN	114	30	100	5	0.4	-35°C~+85°C	-35°C~+85°C
INND-TT40BXX	Blue	InGaN	114	30	100	5	0.4	-35°C~+85°C	-35°C~+85°C
INND-TT40WXX	White	InGaN	114	30	100	5	0.4	-35°C~+85°C	-35°C~+85°C

Notes

1. Condition for I_{FP} is pulse of 1/10 duty and 0.1msec width
2. The device cannot operate under continuous reverse voltage.

Electrical Characteristics T_A = 25℃ (Note 1)

Product (Per Segment)	Emission Color	VF(V)@20mA			λ(nm)@20mA		I*V(mcd)@5mA			IR(μA)@VR=5V	IV-M @IF =5mA
		min	typ.	max	λD	λP	min	typ.	max	max	max
INND-TT40YGXX	Yellow Green	-	2.1	2.8	570	572	-	4	-	100	2:1
INND-TT40YXX	Yellow	-	2.1	2.8	590	592	-	15	-	100	2:1
INND-TT40AXX	Amber	-	2.0	2.8	605	612	-	12	-	100	2:1
INND-TT40RXX	Red	-	2.0	2.8	630	644	-	9	-	100	2:1
INND-TT40DRXX	Deep Red		2.0	2.8	642	660	-	7	-	100	2:1
INND-TT40GXX	Green	-	3.2	3.8	525	-	-	55	-	100	2:1
INND-TT40BXX	Blue	-	3.2	3.8	470	-	-	15	-	50	2:1
INND-TT40WXX	White	-	3.2	3.8	X: 0.27 Y: 0.25	-	-	80	-	50	2:1

Notes
1. Performance guaranteed only under conditions listed in above tables.

ESD Precaution

ATTENTION: Electrostatic Discharge (ESD) protection

The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly.
If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).

Characteristic Curves for YG, Y, A, R, DR, G

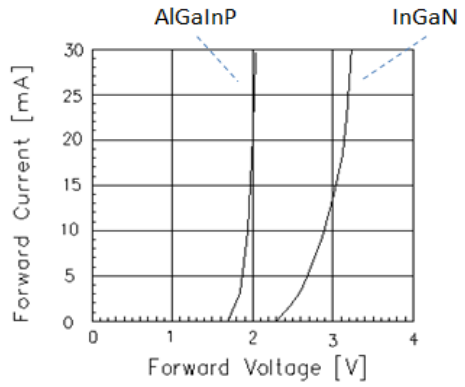


Fig 1. Forward Current vs. Forward Voltage

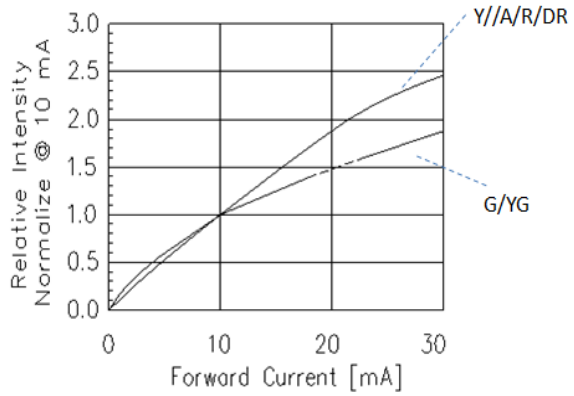


Fig 2. Relative Intensity vs. Forward Current

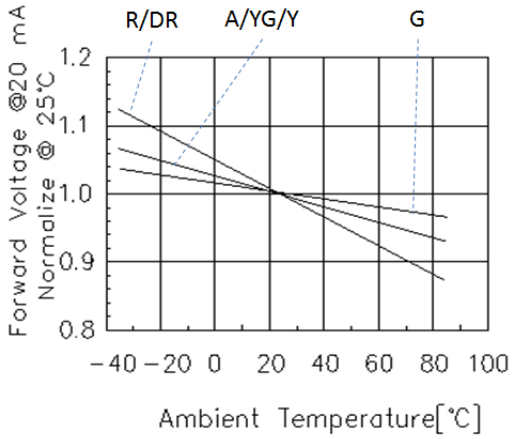


Fig 3. Forward Voltage vs. Temperature

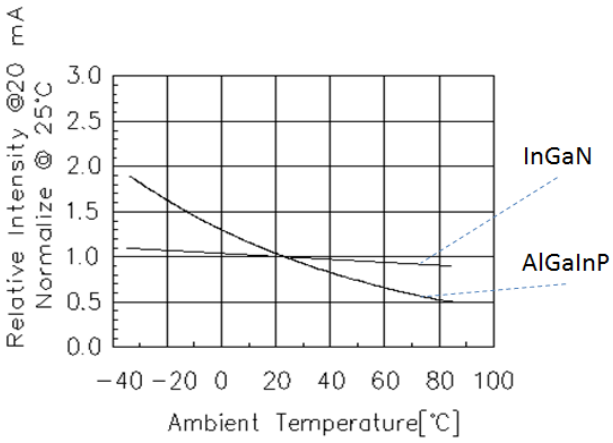


Fig 4. Relative Intensity vs. Temperature

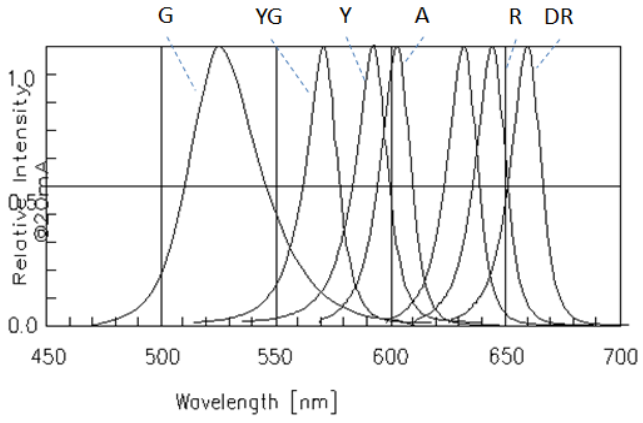


Fig 5. Relative Intensity vs. Wavelength

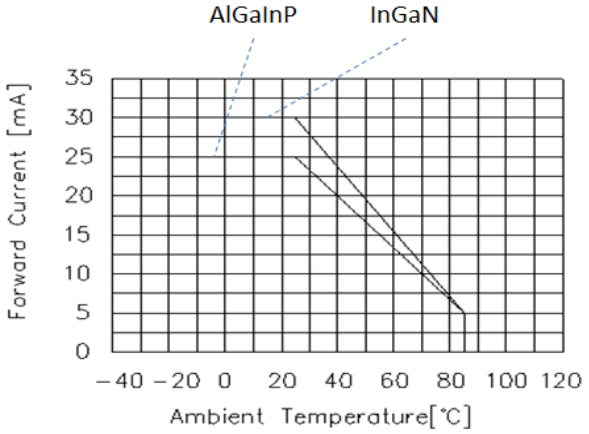


Fig 6. Forward current vs. Temperature

Characteristic Curves for B

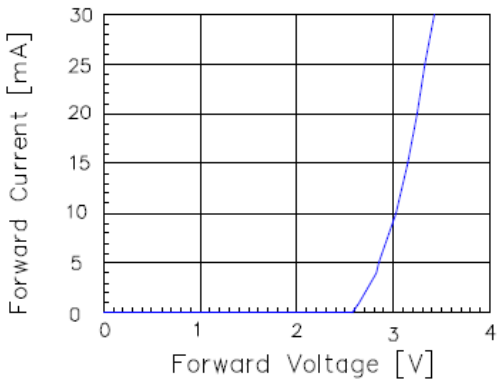


Fig 1. Forward Current vs. Forward Voltage

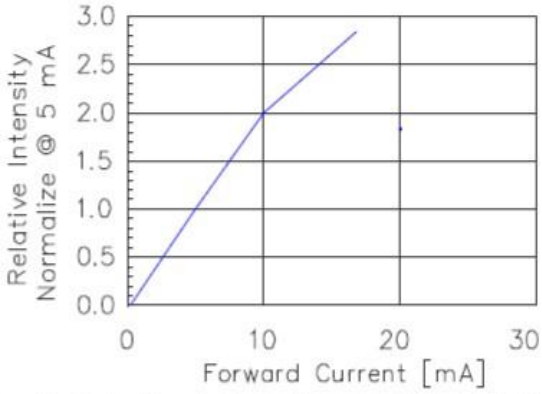


Fig 2. Relative Intensity vs. Forward Current

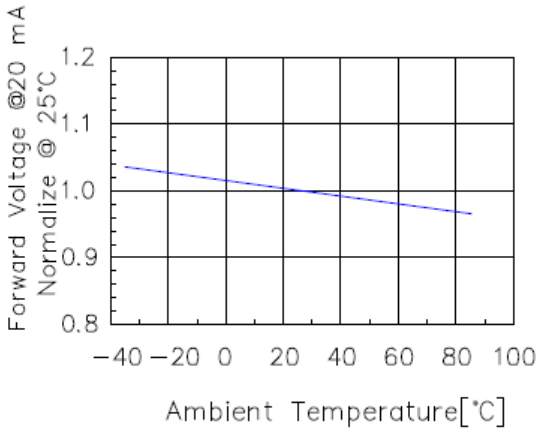


Fig 3. Forward Voltage vs. Temperature

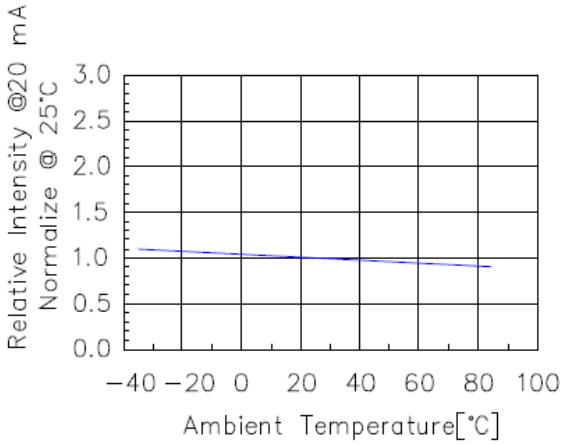


Fig 4. Relative Intensity vs. Temperature

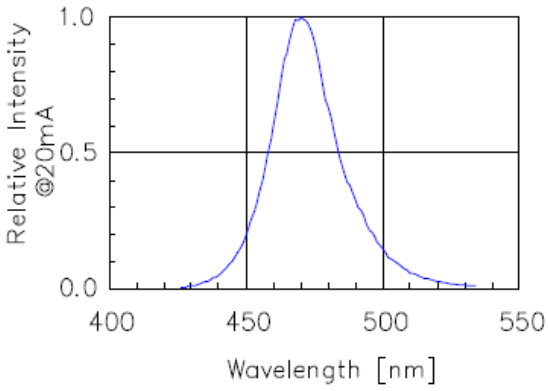


Fig 5. Relative Intensity vs. Wavelength

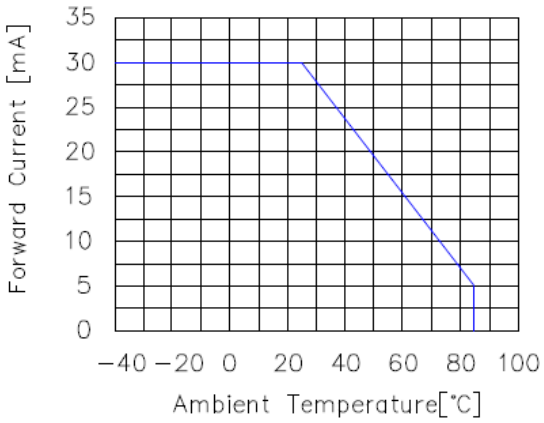


Fig 6. Forward current vs. Temperature

Characteristic Curves for W

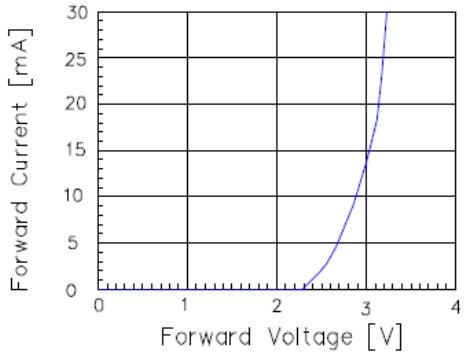


Fig 1. Forward Current vs. Forward Voltage

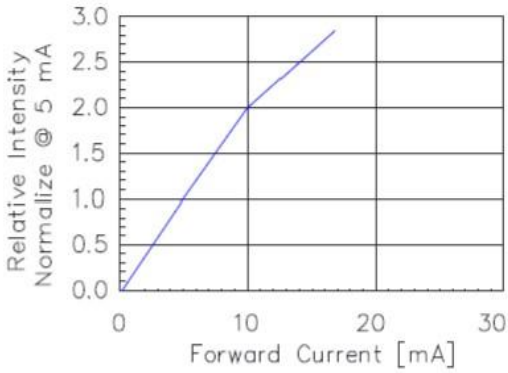


Fig 2. Relative Intensity vs. Forward Current

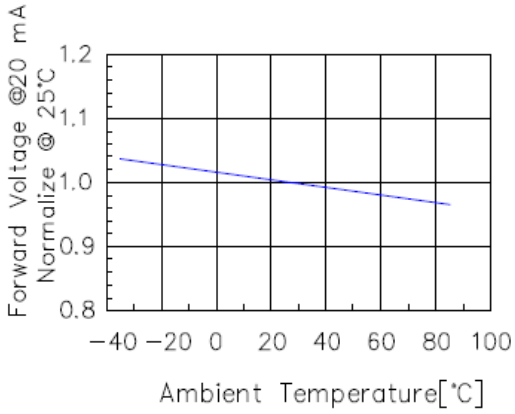


Fig 3. Forward Voltage vs. Temperature

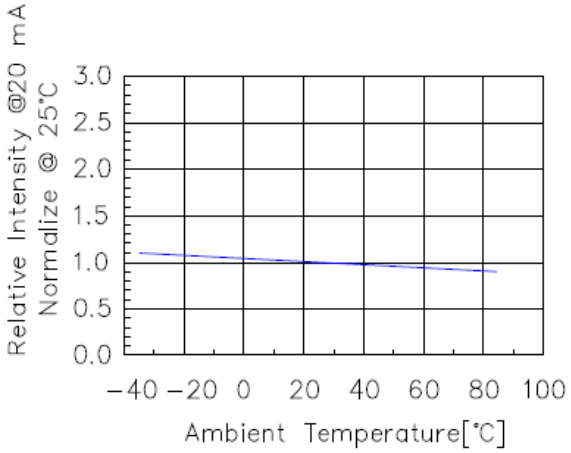


Fig 4. Relative Intensity vs. Temperature

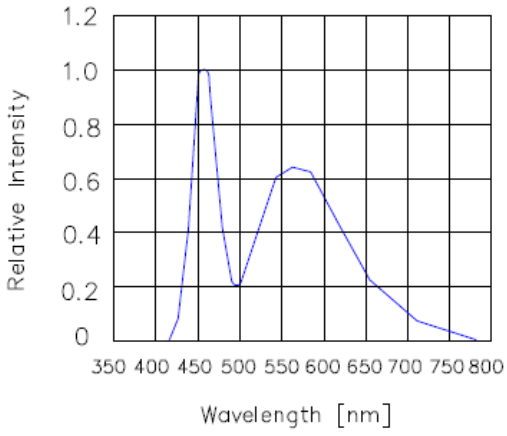


Fig 5. Relative Intensity vs. Wavelength

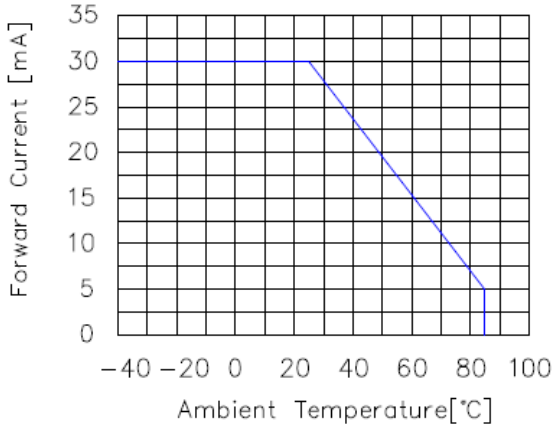
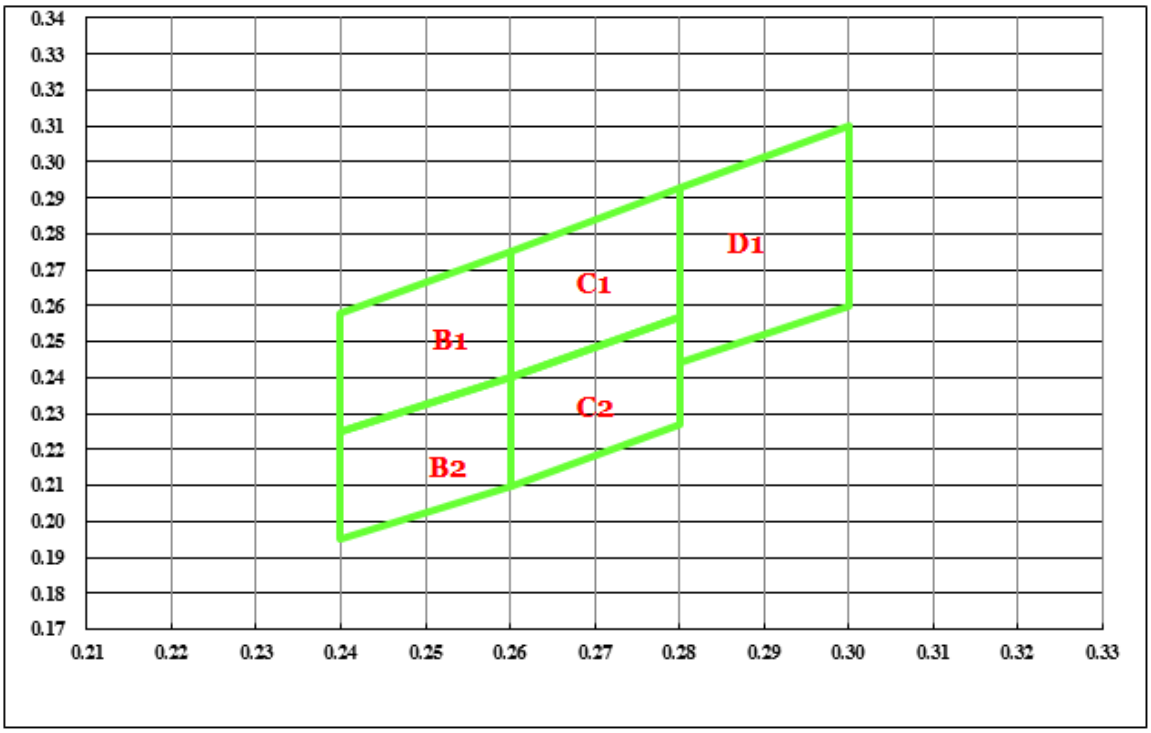


Fig 6. Forward current vs. Temperature

Chromaticity Bin (for White only)



B1				
X	0.240	0.240	0.260	0.260
Y	0.225	0.258	0.275	0.240

B2				
X	0.240	0.240	0.260	0.260
Y	0.195	0.225	0.240	0.210

C1				
X	0.260	0.260	0.280	0.280
Y	0.240	0.275	0.293	0.257

C2				
X	0.260	0.260	0.280	0.280
Y	0.210	0.240	0.257	0.227

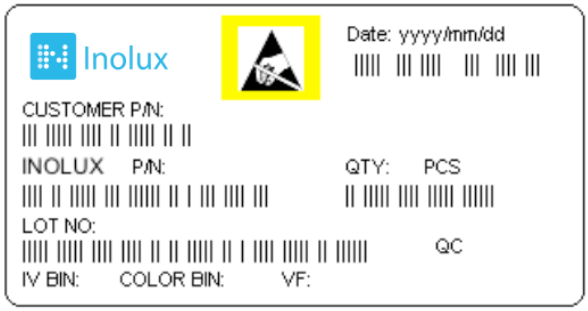
D1				
X	0.280	0.280	0.300	0.300
Y	0.244	0.293	0.310	0.260

Ordering Information

Product	Emission Color	Technology	I*V(mcd) @5mA	VF(V) @20mA	Polarity	Face Color	Orderable Part Number
INND-TT40YGXX	Yellow Green	AlGaInP	4	2.1	Common Anode	Black	INND-TT40YGAB
					Common Cathode	Black	INND-TT40YGCB
					Common Anode	Grey	INND-TT40YGAG
					Common Cathode	Grey	INND-TT40YGCG
INND-TT40YXX	Yellow	AlGaInP	15	2.1	Common Anode	Black	INND-TT40YAB
					Common Cathode	Black	INND-TT40YCB
					Common Anode	Grey	INND-TT40YAG
					Common Cathode	Grey	INND-TT40YCG
INND-TT40AXX	Amber	AlGaInP	12	2.0	Common Anode	Black	INND-TT40AAB
					Common Cathode	Black	INND-TT40ACB
					Common Anode	Grey	INND-TT40AAG
					Common Cathode	Grey	INND-TT40ACG
INND-TT40RXX	Red	AlGaInP	9	2.0	Common Anode	Black	INND-TT40RAB
					Common Cathode	Black	INND-TT40RCB
					Common Anode	Grey	INND-TT40RAG
					Common Cathode	Grey	INND-TT40RCG
INND-TT40DRXX	Deep Red	AlGaInP	7	2.0	Common Anode	Black	INND-TT40DRAB
					Common Cathode	Black	INND-TT40DRCB
					Common Anode	Grey	INND-TT40DRAG
					Common Cathode	Grey	INND-TT40DRCG

Product	Emission Color	Technology	I*V(mcd) @10mA	VF(V) @20mA	Polarity	Face Color	Orderable Part Number
INND-TT40GXX	Green	InGaN	55	3.2	Common Anode	Black	INND-TT40GAB
					Common Cathode	Black	INND-TT40GCB
					Common Anode	Grey	INND-TT40GAG
					Common Cathode	Grey	INND-TT40GCG
INND-TT40BXX	Blue	InGaN	15	3.2	Common Anode	Black	INND-TT40BAB
					Common Cathode	Black	INND-TT40BCB
					Common Anode	Grey	INND-TT40BAG
					Common Cathode	Grey	INND-TT40BCG
INND-TT40WXX	White	InGaN	80	3.2	Common Anode	Black	INND-TT40WAB
					Common Cathode	Black	INND-TT40WCB
					Common Anode	Grey	INND-TT40WAG
					Common Cathode	Grey	INND-TT40WCG

Label Specifications



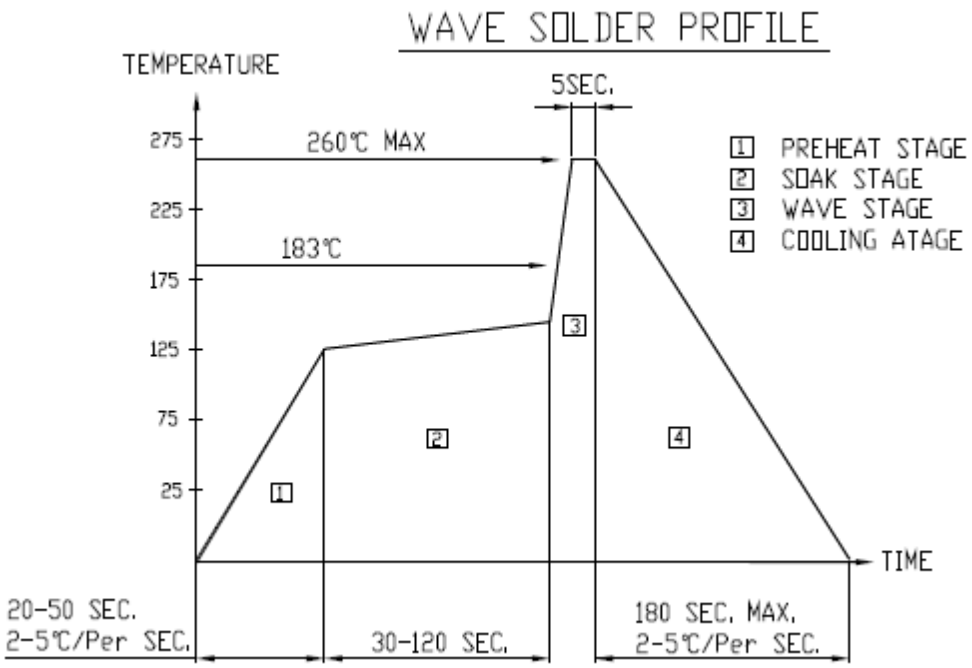
Inolux P/N:

I	N	N	D	-	T	T	4	0	X	X	X	-	X	X	X	X
		Display Type			Display Type		Dimension		Color	Polarity	Face Color		Customized Stamp-off			
Inolux		ND = Numeric Display			T: Through hole T: Triple		40 = 0.4” Display Height		YG: 570 nm Y: 590 nm A: 605 nm R: 624 nm DR:642 nm G: 520 nm B: 470 nm W: X: 0.27 Y: 0.25	A = Common Anode C=Common Cathode	B = Black G = Grey					

Lot No.:

Z	2	0	1	7	01	24	001
Internal Tracker	Year (2017, 2018, …..)				Month	Date	Serial

Reflow Soldering



Soldering Iron

Basic Spec is ≦ 4 sec. when 260°C (+10°C ➔ -1 second). Power dissipation of Iron should be less than 15W. Surface temperature should be under 230°C

Rework

Rework should be completed within 4 second under 245°C

Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release		1.0	05-27-2020

DISCLAIMER

INOLUX reserves the right to make changes without further notice to any products herein to improve reliability, function or design. INOLUX does not assume any liability arising out of the application or use of any product or circuit described herein; neither does it convey any license under its patent rights, nor the rights of others.

LIFE SUPPORT POLICY

INOLUX’s products are not authorized for use as critical components in life support devices or systems without the express written approval of the President of INOLUX or INOLUX CORPORATION. As used herein:
1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.